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**ON Semiconductor**<sup>®</sup>

## FDC3612 100V N-Channel PowerTrench<sup>®</sup> MOSFET

#### **General Description**

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low  $R_{DS(ON)}$  and fast switching speed.

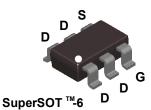
#### Applications

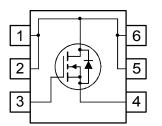
DC/DC converter

#### Features

FDC3612

- High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$
- Low gate charge (14nC typ)
- High power and current handling capability
- Fast switching speed





### Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V <sub>DSS</sub>	Drain-Source Voltage			100	V
V <sub>GSS</sub>	Gate-Source	e Voltage		± 20	V
I <sub>D</sub>	Drain Curre	nt – Continuous	(Note 1a)	2.6	A
		<ul> <li>Pulsed</li> </ul>		20	
E <sub>AS</sub>	Single Pulse	e Avalanche Energy	(Note 3)	37 m	
P <sub>D</sub>	Maximum Power Dissipation		(Note 1a)	1.6	W
			(Note 1b)	0.8	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			–55 to +150	
Therma R <sub>0JA</sub>		teristics	Ambient (Note 1a)	78	°C/W
R <sub>ejc</sub>	Thermal Resistance, Junction-to-Case		· · ·	30	°C/W
Packag		g and Orderin	g Information		
Device Marking		Device	Reel Size	Tape width	Quantity
.362		FDC3612	7"	8mm	3000 units

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Units ..... Min T J Λ /<sup>/</sup> /<sup>0</sup>C Α Α Α Α //<sup>0</sup>C

FDC3612

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-Sc	Durce Avalanche Ratings (Note	2)			l	
W <sub>DSS</sub>	Drain-Source Avalanche Energy	Single Pulse, $V_{DD}$ = 50 V, $I_D$ =2.6 A			90	mJ
I <sub>AR</sub>	Drain-Source Avalanche Current				2.6	Α
Off Char	racteristics					
3V <sub>DSS</sub> Drain–Source Breakdown Voltage		V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	100			V
$\Delta BV_{DSS} \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$		99		mV/°C
IDSS	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V			10	μA
I <sub>GSSF</sub>	Gate-Body Leakage, Forward	V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V			100	nA
I <sub>GSSR</sub>	Gate–Body Leakage, Reverse	$V_{GS} = -20 V, V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	2	2.3	4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C		- 6		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On Resistance	$V_{GS} = 10 \text{ V}, I_D = 2.6 \text{ A} \\ V_{GS} = 6.0 \text{ V}, I_D = 2.5 \text{ A} \\ V_{GS} = 10 \text{ V}, I_D = 2.6 \text{ A}; T_J = 125^{\circ}\text{C}$		86 91 157	125 135 240	mΩ
I <sub>D(on)</sub>	On-State Drain Current	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 5 V	10			Α
<b>g</b> <sub>FS</sub>	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 2.6 \text{ A}$		10		S
Dvnamio	c Characteristics					
Ciss	Input Capacitance	$V_{DS} = 50 V$ , $V_{GS} = 0 V$ ,		660		pF
C <sub>iss</sub> C <sub>oss</sub>	Input Capacitance Output Capacitance	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V, f = 1.0 MHz		660 55		pF pF
	· · ·					•
Coss	Output Capacitance		0.1	55	3.0	pF
C <sub>oss</sub> C <sub>rss</sub> R <sub>g</sub>	Output Capacitance Reverse Transfer Capacitance Gate Resistance		0.1	55 40	3.0	pF pF
C <sub>oss</sub> C <sub>rss</sub> R <sub>g</sub> Switchir	Output Capacitance Reverse Transfer Capacitance Gate Resistance <b>g Characteristics</b> (Note 2)	f = 1.0 MHz	0.1	55 40	3.0	pF pF
C <sub>oss</sub> C <sub>rss</sub> R <sub>g</sub> Switchir t <sub>d(on)</sub>	Output Capacitance Reverse Transfer Capacitance Gate Resistance		0.1	55 40 1.4	- <u> </u>	pF pF Ω
Coss           Crss           Rg           Switchir           t <sub>d(on)</sub> tr	Output Capacitance Reverse Transfer Capacitance Gate Resistance <b>g Characteristics</b> (Note 2) Turn–On Delay Time	f = 1.0 MHz V <sub>DD</sub> = 50 V, I <sub>D</sub> = 1 A,	0.1	55 40 1.4 6	11	pF pF Ω ns
C <sub>oss</sub> C <sub>rss</sub> R <sub>g</sub> Switchir t <sub>d(on)</sub>	Output Capacitance Reverse Transfer Capacitance Gate Resistance <b>g Characteristics</b> (Note 2) Turn–On Delay Time Turn–On Rise Time	f = 1.0 MHz V <sub>DD</sub> = 50 V, I <sub>D</sub> = 1 A,	0.1	55 40 1.4 6 3.5	11 7	pF pF Ω ns
$\begin{array}{c} C_{oss} \\ \hline C_{rss} \\ \hline R_g \\ \hline \textbf{Switchir} \\ \hline t_{d(on)} \\ \hline t_r \\ \hline t_{d(off)} \\ \hline \end{array}$	Output Capacitance Reverse Transfer Capacitance Gate Resistance <b>g Characteristics</b> (Note 2) Turn–On Delay Time Turn–On Rise Time Turn–Off Delay Time	f = 1.0 MHz V <sub>DD</sub> = 50 V, I <sub>D</sub> = 1 A,	0.1	55 40 1.4 6 3.5 23	11 7 37	pF pF Ω ns ns
$\begin{array}{c} C_{oss} \\ \hline C_{rss} \\ \hline R_g \\ \hline \textbf{Switchir} \\ t_{d(on)} \\ \hline t_r \\ t_{d(off)} \\ \hline t_r \\ t_f \\ \end{array}$	Output Capacitance Reverse Transfer Capacitance Gate Resistance <b>g Characteristics</b> (Note 2) Turn–On Delay Time Turn–On Rise Time Turn–Off Delay Time Turn–Off Fall Time	f = 1.0 MHz $V_{DD}$ = 50 V, $I_D$ = 1 A, $V_{GS}$ = 10 V, $R_{GEN}$ = 6 Ω	0.1	55 40 1.4 6 3.5 23 3.7	11 7 37 7.4	pF pF Ω ns ns ns ns
$\begin{array}{c} \hline C_{oss} \\ \hline C_{rss} \\ \hline R_g \\ \hline \textbf{Switchir} \\ \hline \textbf{t}_{d(on)} \\ \hline t_r \\ \hline t_{d(off)} \\ \hline t_r \\ \hline q_g \\ \hline \end{array}$	Output Capacitance Reverse Transfer Capacitance Gate Resistance <b>g Characteristics</b> (Note 2) Turn–On Delay Time Turn–On Rise Time Turn–Off Delay Time Turn–Off Fall Time Total Gate Charge	f = 1.0 MHz $V_{DD} = 50 V$ , $I_D = 1 A$ , $V_{GS} = 10 V$ , $R_{GEN} = 6 Ω$ $V_{DS} = 50 V$ , $I_D = 2.6 A$ ,	0.1	55 40 1.4 6 3.5 23 3.7 14	11 7 37 7.4	pF pF Ω ns ns ns nc
Coss           Crss           Rg           Switchir           td(on)           tr           td(off)           tf           Qg           Qgs           Qgd	Output Capacitance Reverse Transfer Capacitance Gate Resistance <b>g Characteristics</b> (Note 2) Turn–On Delay Time Turn–On Rise Time Turn–Off Delay Time Turn–Off Fall Time Total Gate Charge Gate–Source Charge Gate–Drain Charge	$f = 1.0 \text{ MHz}$ $V_{DD} = 50 \text{ V}, \qquad I_D = 1 \text{ A},$ $V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$ $V_{DS} = 50 \text{ V}, \qquad I_D = 2.6 \text{ A},$ $V_{GS} = 10 \text{ V}$	0.1	55 40 1.4 6 3.5 23 3.7 14 2.3	11 7 37 7.4	pF pF Ω ns ns ns nC nC
Coss           Crss           Rg           Switchir           t <sub>d(on)</sub> tr           t <sub>d(off)</sub> t <sub>f</sub> Qg           Qgd           Drain–So	Output Capacitance Reverse Transfer Capacitance Gate Resistance <b>g Characteristics</b> (Note 2) Turn–On Delay Time Turn–On Rise Time Turn–Off Delay Time Turn–Off Fall Time Total Gate Charge Gate–Source Charge	$f = 1.0 \text{ MHz}$ $V_{DD} = 50 \text{ V}, \qquad I_D = 1 \text{ A},$ $V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$ $V_{DS} = 50 \text{ V}, \qquad I_D = 2.6 \text{ A},$ $V_{GS} = 10 \text{ V}$ and Maximum Ratings	0.1	55 40 1.4 6 3.5 23 3.7 14 2.3	11 7 37 7.4	pF pF Ω ns ns ns nC nC
Coss           Crss           Rg           Switchir           td(on)           tr           td(off)           tf           Qg           Qgs           Qgd	Output Capacitance Reverse Transfer Capacitance Gate Resistance <b>g Characteristics</b> (Note 2) Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge <b>ource Diode Characteristics</b> Maximum Continuous Drain-Source Drain-Source Diode Forward	$f = 1.0 \text{ MHz}$ $V_{DD} = 50 \text{ V}, \qquad I_D = 1 \text{ A},$ $V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$ $V_{DS} = 50 \text{ V}, \qquad I_D = 2.6 \text{ A},$ $V_{GS} = 10 \text{ V}$ and Maximum Ratings	0.1	55 40 1.4 6 3.5 23 3.7 14 2.3	11 7 37 7.4 20	pF pF Ω ns ns ns nC nC nC
Coss           Crss           Rg           Switchir           ta(on)           tr           tq(off)           tr           Qg           Qgd           Drain–So	Output Capacitance Reverse Transfer Capacitance Gate Resistance <b>g Characteristics</b> (Note 2) Turn–On Delay Time Turn–On Rise Time Turn–Off Delay Time Turn–Off Fall Time Total Gate Charge Gate–Source Charge Gate–Drain Charge <b>ource Diode Characteristics</b> Maximum Continuous Drain–Source	$f = 1.0 \text{ MHz}$ $V_{DD} = 50 \text{ V},  I_D = 1 \text{ A},$ $V_{GS} = 10 \text{ V},  R_{GEN} = 6 \Omega$ $V_{DS} = 50 \text{ V},  I_D = 2.6 \text{ A},$ $V_{GS} = 10 \text{ V}$ and Maximum Ratings Diode Forward Current	0.1	55 40 1.4 6 3.5 23 3.7 14 2.3 3.6	11 7 37 7.4 20 1.3	pF pF Ω ns ns ns nc nC nC

 $T_A = 25^{\circ}C$  unless otherwise noted

Notes:

1. R<sub>0JA</sub> is the sum of the junction-to-case and case-to-ambient resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $\rm R_{_{\theta JC}}$  is guaranteed by design while  $\rm R_{_{\theta CA}}$  is determined by the user's board design.

a.  $78^{\circ}$ C/W when mounted on a  $1in^2$  pad of 2oz copper on FR-4 board.

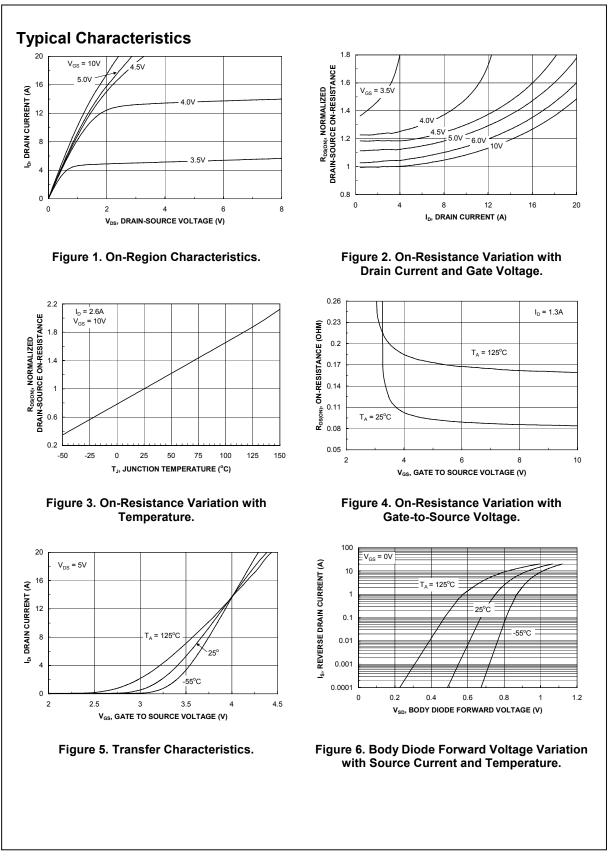
b. 156°C/W when mounted on a minimum pad.

2. Pulse Test: Pulse Width  $\leq$  300  $\mu s,$  Duty Cycle  $\leq$  2.0%

**Electrical Characteristics** 

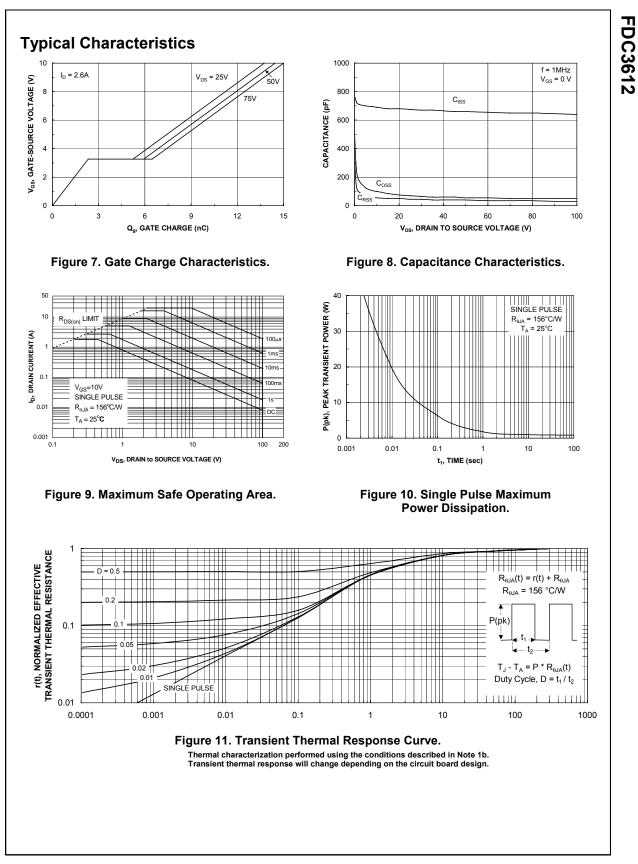
3.  $E_{AS}$  of 37 mJ is based on starting  $T_J$  = 25 °C; N-ch: L = 3 mH,  $I_{AS}$  = 5 A,  $V_{DD}$  = 100 V,  $V_{GS}$  = 10 V. 100% test at L = 0.3 mH,  $I_{AS}$  = 11 A.

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